L Number	Hits	Search Text	DB	Time stamp
2	2113229	resistance neatemperature	USPAT; US-PGPUB; EPO; JPO; DERWENT;	2004/08/19 15:00
3	32732	resistance near temperature	IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT;	2004/08/19 15:00
4	532	increasing near temperature near rapidly	IBM_TDB USPAT; US-PGPUB; EPO; JPO;	2004/08/19 15:01
5	65	ceramic and gas adj sensor and (heater or heating adj element) near embedded	DERWENT; IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT;	2004/08/19 15:02
6	0	(increasing near temperature near rapidly) and (ceramic and gas adj sensor and (heater or heating adj element) near embedded)	IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT;	2004/08/19 15:02
7	14	<pre>(resistance near temperature) and (increasing near temperature near rapidly)</pre>	IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT;	2004/08/19 15:02
8	0	(ceramic and gas adj sensor and (heater or heating adj element) near embedded) and ((resistance near temperature) and (increasing near temperature near	IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT;	2004/08/19 15:02
9	501	rapidly)) ceramic and gas adj sensor and embedded	IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT;	2004/08/19 15:02
10	0	((resistance near temperature) and (increasing near temperature near rapidly)) and (ceramic and gas adj sensor and embedded)	IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT;	2004/08/19 15:02
11	118478	219/\$.ccls.	IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT;	2004/08/19 15:03
12	122	heating near gas near sensor	IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT;	2004/08/19 15:03
13	4	(ceramic and gas adj sensor and heat\$ near embedded) and (heating near gas near sensor)	IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT;	2004/08/19 15:06
15	0	(increasing near temperature near rapidly) and ((ceramic and gas adj sensor and embedded) and 219/\$.ccls.)	IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT;	2004/08/19 15:06
17	3	((resistance near temperature) and (increasing near temperature near rapidly)) and 219/\$.ccls.	IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/08/19 15:06

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p				F
16	25	1 '	USPAT;	2004/08/19
		rapidly) and 219/\$.ccls.	US-PGPUB;	15:08
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	2004/00/10
14	16		USPAT;	2004/08/19
		and 219/\$.ccls.	US-PGPUB;	15:33
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	0004/00/00
20	2	1	USPAT;	2004/08/19
		rapidly	US-PGPUB;	15:35
			EPO; JPO;	
			DERWENT;	
		<u>,                                     </u>	IBM_TDB	0004/00/10
19	2		USPAT;	2004/08/19
		slowly	US-PGPUB;	15:36
			EPO; JPO;	i
			DERWENT;	
			IBM_TDB	
18	1	<u></u>	USPAT;	2004/08/19
		temperature adj heater	US-PGPUB;	15:35
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	0004/00/40
21	72		USPAT;	2004/08/19
		(ceramic and gas adj sensor and embedded)	US-PGPUB;	15:37
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	0004400410
22	4		USPAT;	2004/08/19
		temperature) and (ceramic and gas adj	US-PGPUB;	15:38
		sensor and embedded))	EPO; JPO;	
			DERWENT;	
			IBM_TDB	2004/00/10
23	27228	controlling and measuring and resistance	USPAT;	2004/08/19
		and rate and increasing and temperature	US-PGPUB;	15:39
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	2004/08/19
24	0		USPAT; US-PGPUB;	15:40
	[	embedded21 and (controlling and measuring	EPO; JPO;	13.70
	1	and resistance and rate and increasing	DERWENT;	
	1	and temperature)	IBM TDB	
ا ا	10	((resistance near temperature) and	USPAT;	2004/08/19
25	12	((resistance hear temperature) and (ceramic and gas adj sensor and	US-PGPUB;	15:45
	[	embedded)) and (controlling and measuring	EPO; JPO;	10.10
	[	and resistance and rate and increasing	DERWENT;	
		and resistance and rate and increasing and temperature)	IBM TDB	
26	643	1	USPAT;	2004/08/19
26	642	measuring and resistance and rate and	US-PGPUB;	15:45
	1	increasing and temperature)	EPO; JPO;	
		Thereasing and cemperature,	DERWENT;	
	1		IBM TDB	
27	1	(ceramic and gas adj sensor and embedded)	USPAT;	2004/08/19
41	1	and (219/\$.ccls. and (controlling and	US-PGPUB;	15:45
		measuring and resistance and rate and	EPO; JPO;	
		increasing and temperature))	DERWENT;	
	1	Thereasing and competatory	IBM TDB	
1	1			

L Number	Hits	Search Text	DB	Time stamp
Number 2	2113229	resistance neatemperature	USPAT; US-PGPUB;	2004/08/19
			EPO; JPO; DERWENT; IBM TDB	10.00
3	32732	resistance near temperature	USPĀT; US-PGPUB; EPO; JPO;	2004/08/19 15:00
4	532	increasing near temperature near rapidly	DERWENT; IBM_TDB USPAT; US-PGPUB;	2004/08/19 15:01
5	65	ceramic and gas adj sensor and (heater or	EPO; JPO; DERWENT; IBM_TDB USPAT;	2004/08/19
		heating adj element) near embedded	US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	15:02
6	0	<pre>(increasing near temperature near rapidly) and (ceramic and gas adj sensor and (heater or heating adj element) near embedded)</pre>	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/08/19 15:02
7	14	<pre>(resistance near temperature) and (increasing near temperature near rapidly)</pre>	USPAT; US-PGPUB; EPO; JPO; DERWENT;	2004/08/19 15:02
8	0	(ceramic and gas adj sensor and (heater or heating adj element) near embedded) and ((resistance near temperature) and (increasing near temperature near	IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT;	2004/08/19 15:02
9	501	rapidly)) ceramic and gas adj sensor and embedded	IBM_TDB USPAT; US-PGPUB; EPO; JPO;	2004/08/19 15:02
10	0	((resistance near temperature) and (increasing near temperature near rapidly)) and (ceramic and gas adj sensor and embedded)	DERWENT; IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT;	2004/08/19 15:02
11	118478	219/\$.ccls.	IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT;	2004/08/19 15:03
12	122	heating near gas near sensor	IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT;	2004/08/19 15:03
13	4	(ceramic and gas adj sensor and heat\$ near embedded) and (heating near gas near sensor)	IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/19 15:06
15	0	(increasing near temperature near rapidly) and ((ceramic and gas adj sensor and embedded) and 219/\$.ccls.)	USPAT; US-PGPUB; EPO; JPO; DERWENT;	2004/08/19 15:06
17	3	((resistance near temperature) and (increasing near temperature near rapidly)) and 219/\$.ccls.	IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/08/19 15:06

16	25	(increasing near temperature near	USPAT;	2004/08/19
		rapidly) and 219/\$.ccls.	US-PGPUB;	15:08
			EPO; JPO;	
			DERWENT;	
i			IBM TDB	
14	16	(ceramic and gas adj sensor and embedded)	USPĀT;	2004/08/19
		and 219/\$.ccls.	US-PGPUB;	15:14
			EPO; JPO;	
			DERWENT;	
			IBM TDB	